

## Final datasheet

### EconoDUAL™3 module with Trench/Fieldstop IGBT4 and emitter controlled diode and NTC

#### Features

- Electrical features
  - $V_{CES} = 650\text{ V}$
  - $I_{C\text{ nom}} = 300\text{ A} / I_{CRM} = 600\text{ A}$
  - Increased blocking voltage capability up to 650 V
  - Increased DC-link voltage
  - High short-circuit capability
  - Trench IGBT 4
  - $T_{vj,op} = 150^{\circ}\text{C}$
- Mechanical features
  - Integrated NTC temperature sensor
  - Isolated base plate
  - Copper base plate
  - PressFIT contact technology
  - Rugged selfacting PressFIT assembly
  - Standard housing



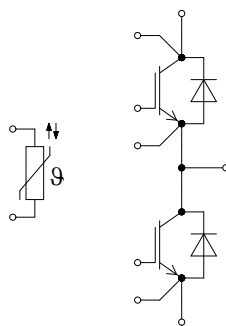
#### Potential applications

- Commercial agriculture vehicles
- Motor drives
- Solar applications
- UPS systems

#### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

#### Description



## Table of contents

	<b>Description</b> .....	1
	<b>Features</b> .....	1
	<b>Potential applications</b> .....	1
	<b>Product validation</b> .....	1
	<b>Table of contents</b> .....	2
<b>1</b>	<b>Package</b> .....	3
<b>2</b>	<b>IGBT, Inverter</b> .....	4
<b>3</b>	<b>Diode, Inverter</b> .....	5
<b>4</b>	<b>NTC-Thermistor</b> .....	6
<b>5</b>	<b>Characteristics diagrams</b> .....	7
<b>6</b>	<b>Circuit diagram</b> .....	10
<b>7</b>	<b>Package outlines</b> .....	11
<b>8</b>	<b>Module label code</b> .....	12
	<b>Revision history</b> .....	13
	<b>Disclaimer</b> .....	14

## 1 Package

**Table 1** Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	$V_{ISOL}$	RMS, $f = 50$ Hz, $t = 1$ min	2.5	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50$ Hz, $t = 1$ min	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	$Al_2O_3$	
Creepage distance	$d_{Creep\ nom}$	terminal to baseplate, nom., (PD2, IEC 60664-1, Ed. 3.0)	> 15	mm
Creepage distance	$d_{Creep\ min}$	terminal to baseplate, min., (PD2, IEC 60664-1, Ed. 3.0)	14.7	mm
Creepage distance	$d_{Creep\ nom}$	terminal to terminal, nom., (PD2, IEC 60664-1, Ed. 3.0)	12.1	mm
Creepage distance	$d_{Creep\ min}$	terminal to terminal, min., (PD2, IEC 60664-1, Ed. 3.0)	11.5	mm
Clearance	$d_{Clear\ nom}$	terminal to baseplate, nom.	> 12.5	mm
Clearance	$d_{Clear\ min}$	terminal to baseplate, min.	12.5	mm
Clearance	$d_{Clear\ nom}$	terminal to terminal, nom.	10.0	mm
Clearance	$d_{Clear\ min}$	terminal to terminal, min.	9.6	mm
Comparative tracking index	$CTI$		> 200	
Relative thermal index (electrical)	$RTI$	housing	140	°C

**Table 2** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	$L_{sCE}$			20		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25$ °C, per switch		1		mΩ
Storage temperature	$T_{stg}$		-40		125	°C
Mounting torque for module mounting	$M$	- Mounting according to valid application note	M5, Screw	3	6	Nm
Terminal connection torque	$M$	- Mounting according to valid application note	M6, Screw	3	6	Nm
Weight	$G$			345		g

## 2 IGBT, Inverter

**Table 3** Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter voltage	$V_{CES}$	$T_{vj} = 25\text{ °C}$		650		V
Continuous DC collector current	$I_{CDC}$	$T_{vj\text{ max}} = 175\text{ °C}$ $T_C = 80\text{ °C}$		300		A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{vj\text{ op}}$		600		A
Gate-emitter peak voltage	$V_{GES}$			±20		V

**Table 4** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 300\text{ A}$ , $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.55	1.95	V
			$T_{vj} = 125\text{ °C}$	1.70		
			$T_{vj} = 150\text{ °C}$	1.75		
Gate threshold voltage	$V_{GETh}$	$I_C = 4.8\text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25\text{ °C}$	5.10	5.80	6.40	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\text{ V}$		3.3		μC
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\text{ °C}$		0.67		Ω
Input capacitance	$C_{ies}$	$f = 1000\text{ kHz}$ , $T_{vj} = 25\text{ °C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$		18.5		nF
Reverse transfer capacitance	$C_{res}$	$f = 1000\text{ kHz}$ , $T_{vj} = 25\text{ °C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$		0.57		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 650\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_{vj} = 25\text{ °C}$			1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{ V}$ , $V_{GE} = 20\text{ V}$ , $T_{vj} = 25\text{ °C}$			100	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 300\text{ A}$ , $V_{CC} = 300\text{ V}$ , $V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 2.2\text{ Ω}$	$T_{vj} = 25\text{ °C}$	0.068		μs
			$T_{vj} = 125\text{ °C}$	0.069		
			$T_{vj} = 150\text{ °C}$	0.072		
Rise time (inductive load)	$t_r$	$I_C = 300\text{ A}$ , $V_{CC} = 300\text{ V}$ , $V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 2.2\text{ Ω}$	$T_{vj} = 25\text{ °C}$	0.060		μs
			$T_{vj} = 125\text{ °C}$	0.065		
			$T_{vj} = 150\text{ °C}$	0.066		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 300\text{ A}$ , $V_{CC} = 300\text{ V}$ , $V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 2.2\text{ Ω}$	$T_{vj} = 25\text{ °C}$	0.380		μs
			$T_{vj} = 125\text{ °C}$	0.410		
			$T_{vj} = 150\text{ °C}$	0.420		

(table continues...)

**Table 4** (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Fall time (inductive load)	$t_f$	$I_C = 300\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 2.2\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.074		$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.097		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.105		
Turn-on energy loss per pulse	$E_{on}$	$I_C = 300\text{ A}, V_{CC} = 300\text{ V}, L_\sigma = 30\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 2.2\ \Omega, di/dt = 4500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	1.8		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	2.8		
			$T_{vj} = 150\text{ }^\circ\text{C}$	3.25		
Turn-off energy loss per pulse	$E_{off}$	$I_C = 300\text{ A}, V_{CC} = 300\text{ V}, L_\sigma = 30\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 2.2\ \Omega, dv/dt = 3000\text{ V}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	14		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	18		
			$T_{vj} = 150\text{ }^\circ\text{C}$	19		
SC data	$I_{SC}$	$V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$	$t_p \leq 10\ \mu\text{s}, T_{vj} = 150\text{ }^\circ\text{C}$	1400		A
Thermal resistance, junction to case	$R_{thJC}$	per IGBT			0.138	K/W
Thermal resistance, case to heat sink	$R_{thCH}$	per IGBT, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.0410		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		150	$^\circ\text{C}$

### 3 Diode, Inverter

**Table 5** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} = 25\text{ }^\circ\text{C}$	650	V	
Continuous DC forward current	$I_F$		300	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1\text{ ms}$	600	A	
$I^2t$ - value	$I^2t$	$t_p = 10\text{ ms}, V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^\circ\text{C}$	8800	$\text{A}^2\text{s}$
			$T_{vj} = 150\text{ }^\circ\text{C}$	7850	

**Table 6** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	$V_F$	$I_F = 300\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$		1.55	1.95	V
			$T_{vj} = 125\text{ °C}$		1.50		
			$T_{vj} = 150\text{ °C}$		1.45		
Peak reverse recovery current	$I_{RM}$	$V_{CC} = 300\text{ V}, I_F = 300\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 4500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ °C})$	$T_{vj} = 25\text{ °C}$		150		A
			$T_{vj} = 125\text{ °C}$		210		
			$T_{vj} = 150\text{ °C}$		225		
Recovered charge	$Q_r$	$V_{CC} = 300\text{ V}, I_F = 300\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 4500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ °C})$	$T_{vj} = 25\text{ °C}$		18.5		$\mu\text{C}$
			$T_{vj} = 125\text{ °C}$		22		
			$T_{vj} = 150\text{ °C}$		25.5		
Reverse recovery energy	$E_{rec}$	$V_{CC} = 300\text{ V}, I_F = 300\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 4500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ °C})$	$T_{vj} = 25\text{ °C}$		4.05		mJ
			$T_{vj} = 125\text{ °C}$		6.45		
			$T_{vj} = 150\text{ °C}$		7.45		
Thermal resistance, junction to case	$R_{thJC}$	per diode			0.215	K/W	
Thermal resistance, case to heat sink	$R_{thCH}$	per diode, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		0.0410		K/W	
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		150	°C	

## 4 NTC-Thermistor

**Table 7** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$R_{25}$	$T_{NTC} = 25\text{ °C}$		5		k $\Omega$
Deviation of $R_{100}$	$\Delta R/R$	$T_{NTC} = 100\text{ °C}, R_{100} = 493\text{ }\Omega$	-5		5	%
Power dissipation	$P_{25}$	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

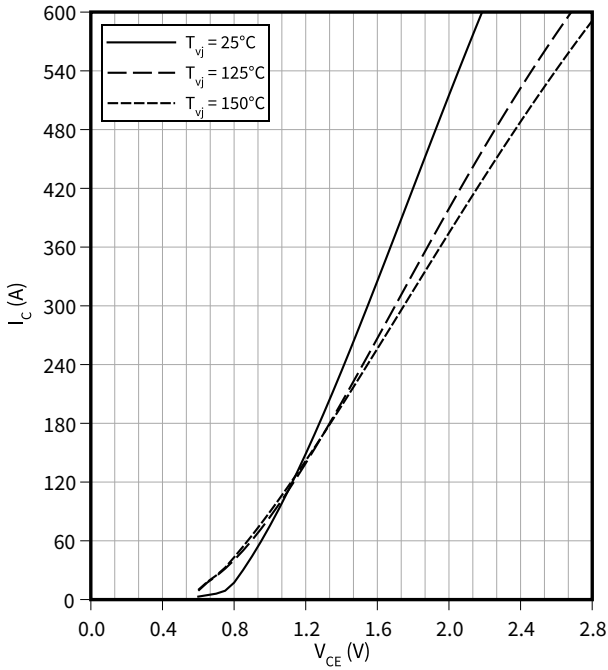
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4

## 5 Characteristics diagrams

### Output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

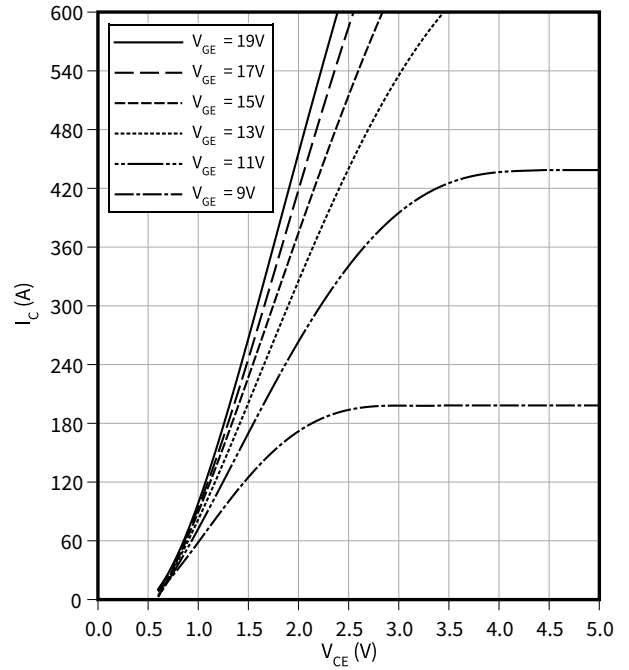
$$V_{GE} = 15 \text{ V}$$



### Output characteristic field (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

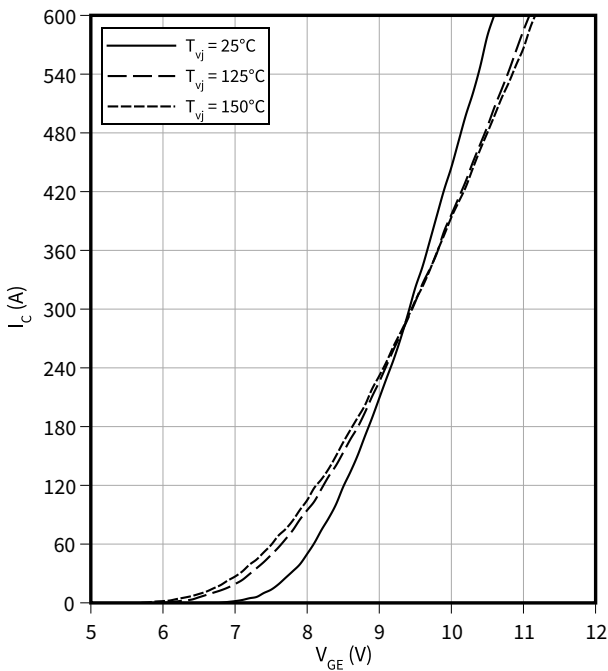
$$T_{vj} = 150 \text{ °C}$$



### Transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

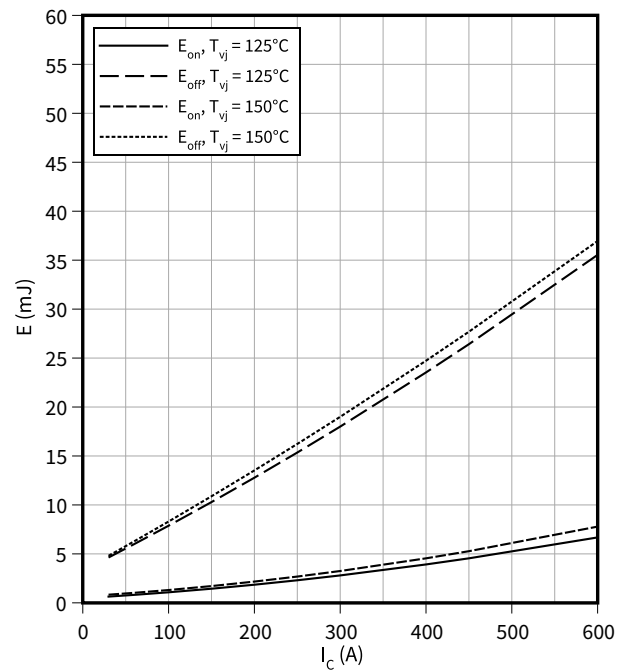
$$V_{CE} = 20 \text{ V}$$



### Switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

$$R_{Gon} = 2.2 \text{ } \Omega, V_{GE} = -15 / 15 \text{ V}, V_{CC} = 300 \text{ V}, R_{Goff} = 2.2 \text{ } \Omega$$

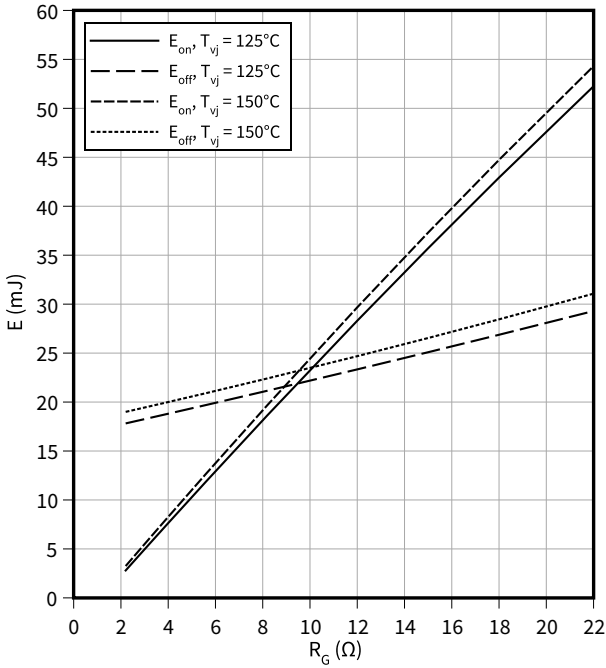


**5 Characteristics diagrams**

**Switching losses (typical), IGBT, Inverter**

$E = f(R_G)$

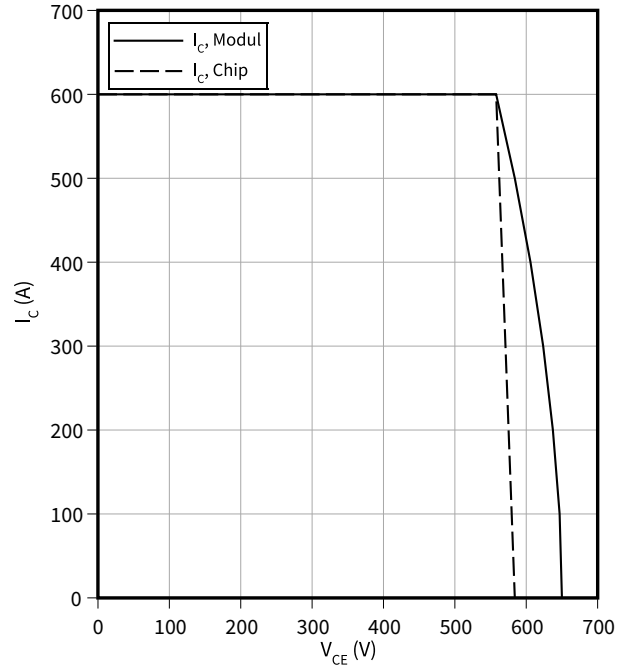
$V_{GE} = -15 / 15 \text{ V}, I_C = 300 \text{ A}, V_{CC} = 300 \text{ V}$



**Reverse bias safe operating area (RBSOA), IGBT, Inverter**

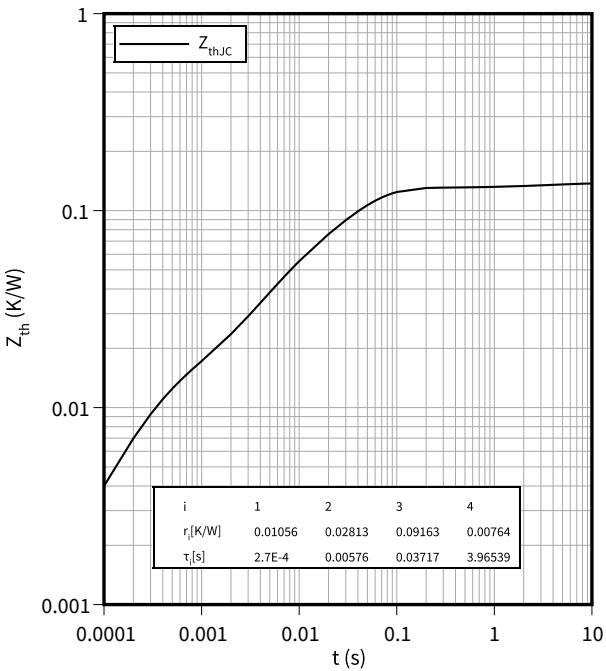
$I_C = f(V_{CE})$

$R_{Goff} = 2.2 \Omega, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150 \text{ °C}$



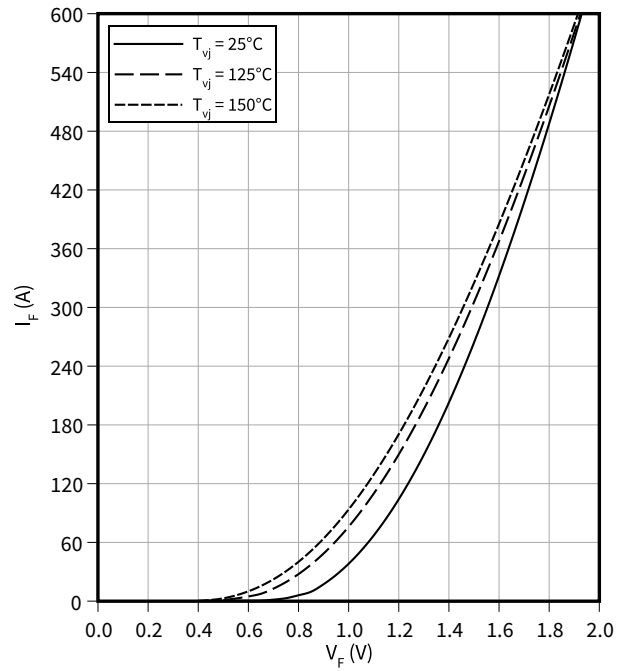
**Transient thermal impedance, IGBT, Inverter**

$Z_{th} = f(t)$



**Forward characteristic (typical), Diode, Inverter**

$I_F = f(V_F)$



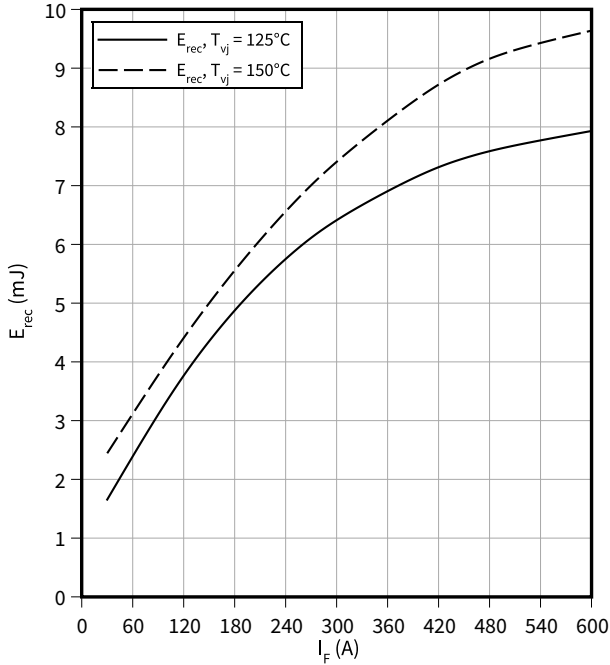


5 Characteristics diagrams

Switching losses (typical), Diode, Inverter

$$E_{rec} = f(I_F)$$

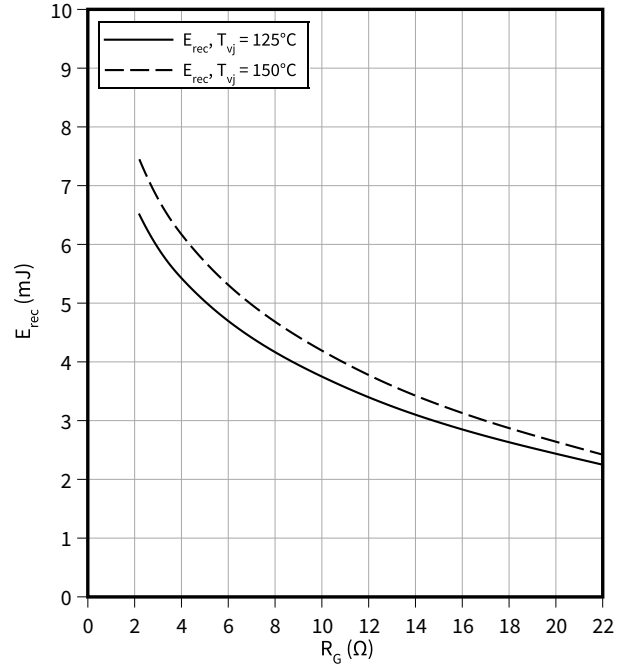
$$R_{Gon} = R_{Gon}(IGBT), V_{CC} = 300 V$$



Switching losses (typical), Diode, Inverter

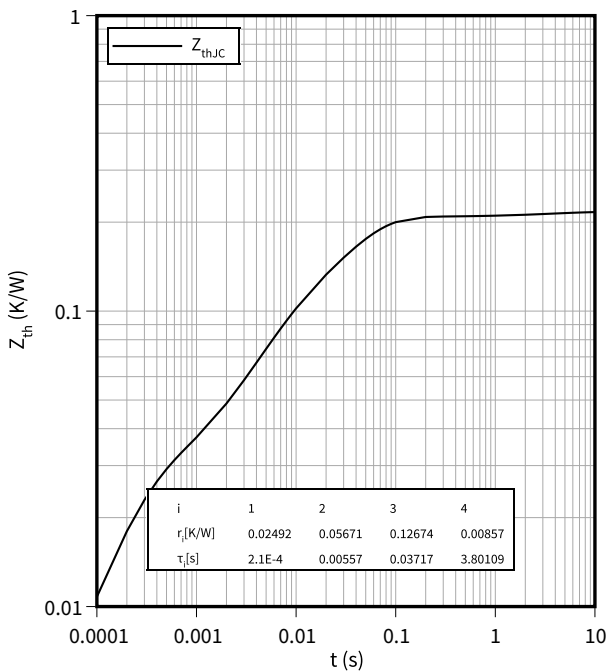
$$E_{rec} = f(R_G)$$

$$I_F = 300 A, V_{CC} = 300 V$$



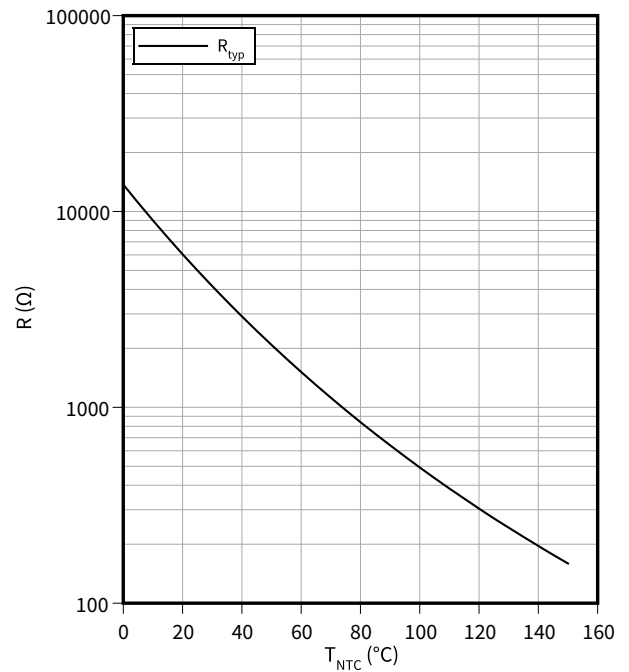
Transient thermal impedance, Diode, Inverter

$$Z_{th} = f(t)$$



Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



## 6 Circuit diagram

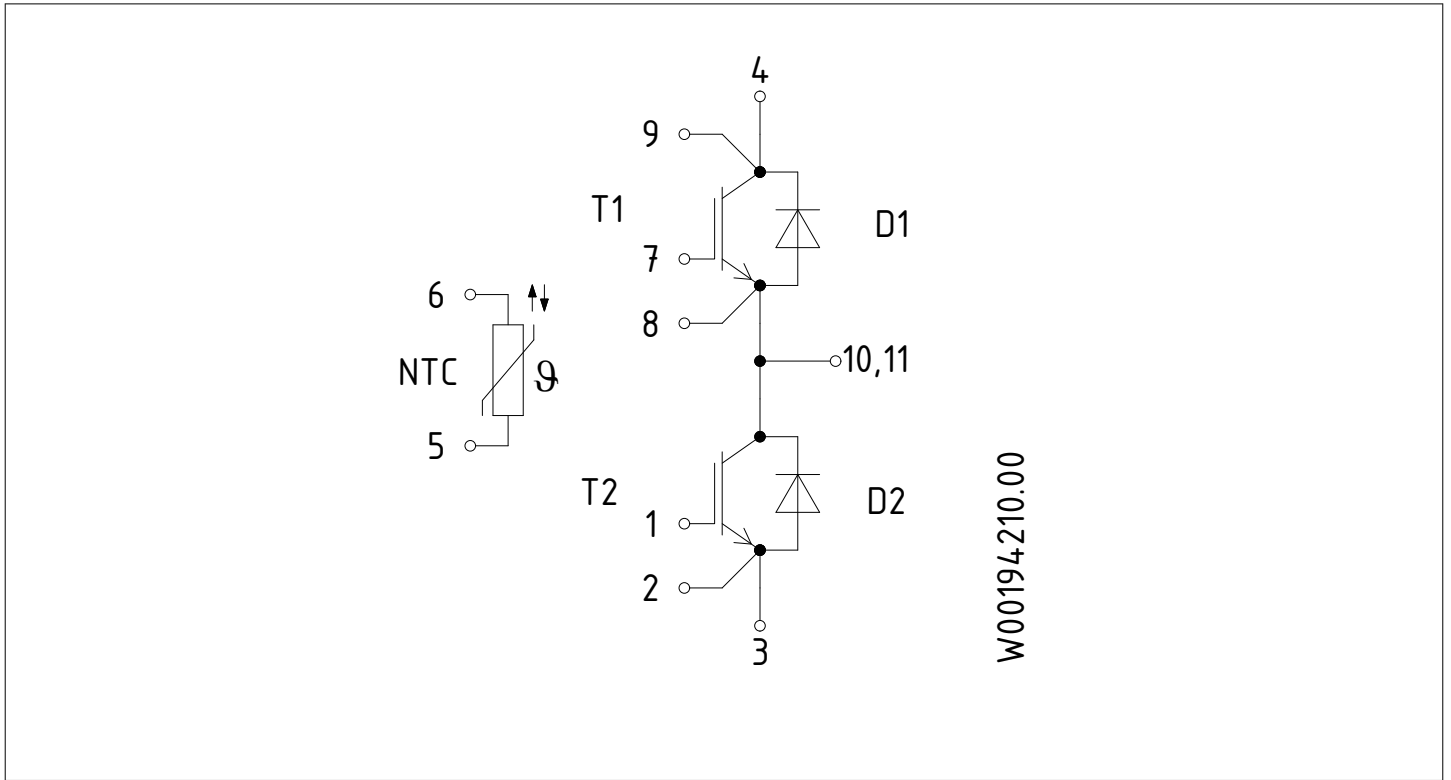


Figure 1

## 7 Package outlines

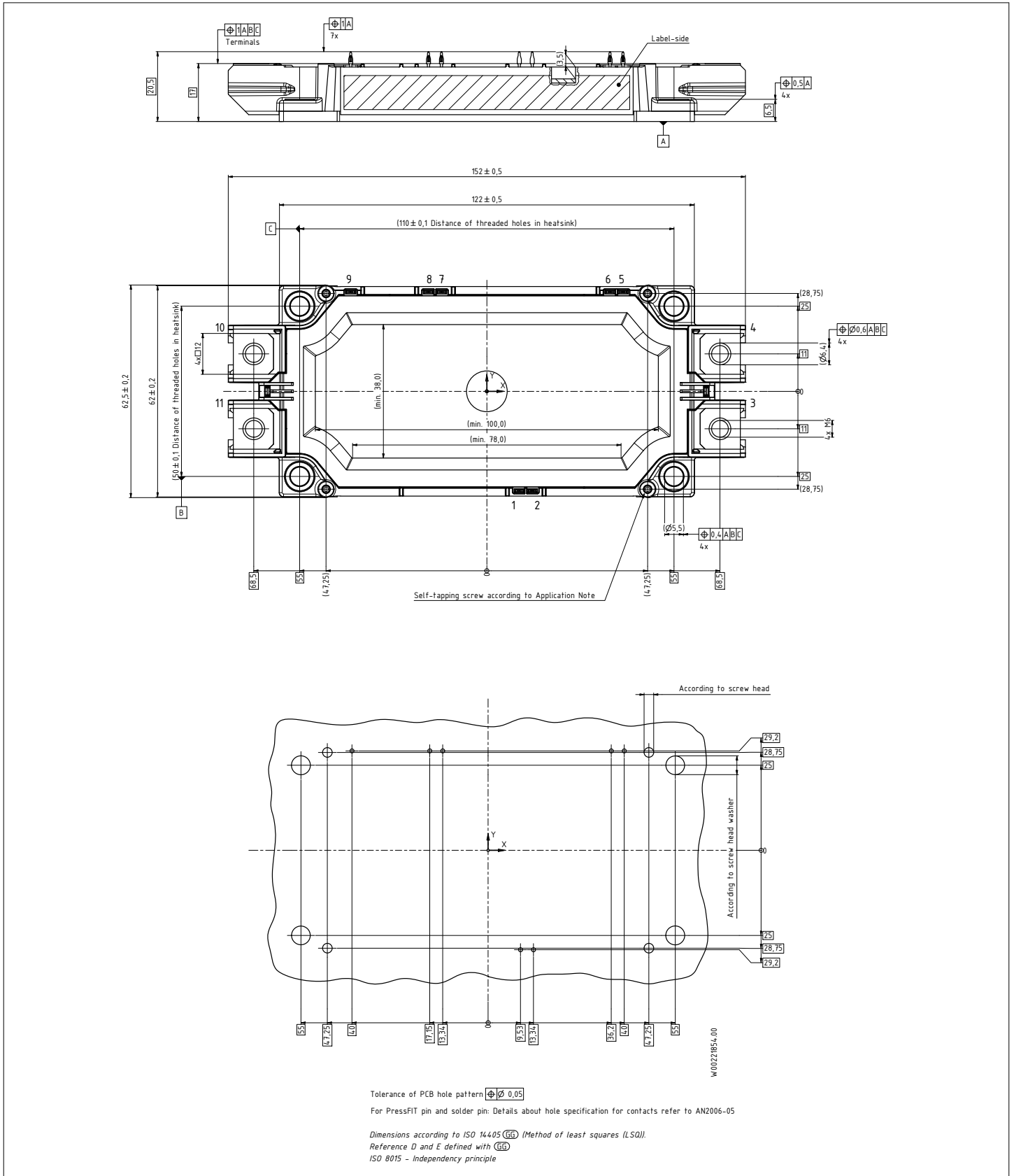

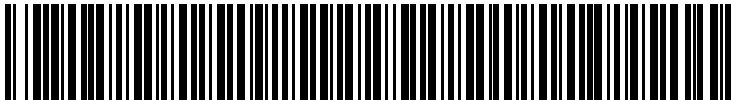


Figure 2

## 8 Module label code

Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 - 5 6 - 11 12 - 19 20 - 21 22 - 23	<i>Example</i> 71549 142846 55054991 15 30
Example	 		<p>71549142846550549911530</p> <p>71549142846550549911530</p>

**Figure 3**

## Revision history

Document revision	Date of release	Description of changes
V1.0	2011-11-08	Target datasheet
V2.0	2012-01-26	Preliminary datasheet
V3.0	2012-04-02	Final datasheet
V3.1	2014-12-15	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2024-03-11	Final datasheet

## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2024-03-11**

**Published by**

**Infineon Technologies AG**

**81726 Munich, Germany**

**© 2024 Infineon Technologies AG**

**All Rights Reserved.**

**Do you have a question about any aspect of this document?**

**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

**Document reference**

**IFX-AAX029-005**

## Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.